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ASSEMBLY INCORPORATING THE SAME****Publication Classification**(71) Applicant: **Aptiv Technologies Limited**, St.
Michael (BB)(51) **Int. Cl.**
H05K 7/20 (2006.01)(72) Inventors: **Jakub Antoni Korta**, Kraków (PL);
Volker Klink, Hennef (DE)(52) **U.S. Cl.**
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(57) **ABSTRACT**

This document describes a cooling device for cooling a heatsink having a plurality of cooling fins provided on a heatsink base. The cooling device includes a centrifugal fan having a fan inlet and a fan outlet, a support for mounting the fan above the heatsink, and a baffle locatable between the support and the heatsink base. The baffle defines an inlet pathway for feeding air between the cooling fins over the heatsink base to the fan inlet and an outlet pathway for expelling air from the fan outlet.

